

## FEATURES

**Recovers signal from 100 dB noise**  
**2 MHz channel bandwidth**  
**45 V/ $\mu$ s slew rate**  
**Low crosstalk:  $-120$  dB at 1 kHz,  $-100$  dB at 10 kHz**  
**Pin programmable, closed-loop gains of  $\pm 1$  and  $\pm 2$**   
**0.05% closed-loop gain accuracy and match**  
**100  $\mu$ V channel offset voltage (AD630)**  
**350 kHz full power bandwidth**  
**Chips available**

## APPLICATIONS

**Balanced modulation and demodulation**  
**Synchronous detection**  
**Phase detection**  
**Quadrature detection**  
**Phase sensitive detection**  
**Lock in amplification**  
**Square wave multiplication**

## GENERAL DESCRIPTION

The AD630 is a high precision balanced modulator/demodulator that combines a flexible commutating architecture with the accuracy and temperature stability afforded by laser wafer trimmed thin film resistors. A network of on-board applications resistors provides precision closed-loop gains of  $\pm 1$  and  $\pm 2$  with 0.05% accuracy (AD630B). These resistors may also be used to accurately configure multiplexer gains of 1, 2, 3, or 4. External feedback enables high gain or complex switched feedback topologies.

The AD630 can be thought of as a precision op amp with two independent differential input stages and a precision comparator that is used to select the active front end. The rapid response time of this comparator coupled with the high slew rate and fast settling of the linear amplifiers minimize switching distortion.

The AD630 is used in precision signal processing and instrumentation applications that require wide dynamic range. When used as a synchronous demodulator in a lock-in amplifier configuration, the AD630 can recover a small signal from 100 dB of interfering noise (see the Lock-In Amplifier Applications section). Although optimized for operation up to 1 kHz, the circuit is useful at frequencies up to several hundred kilohertz.

## FUNCTIONAL BLOCK DIAGRAM

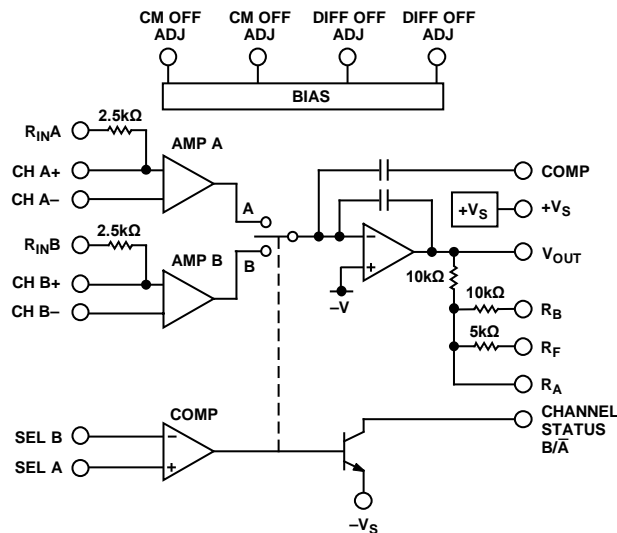


Figure 1.

Other features of the AD630 include pin programmable frequency compensation; optional input bias current compensation resistors, common-mode and differential-offset voltage adjustment, and a channel status output that indicates which of the two differential inputs is active.

## PRODUCT HIGHLIGHTS

1. The application flexibility of the AD630 makes it the best choice for applications that require precisely fixed gain, switched gain, multiplexing, integrating-switching functions, and high speed precision amplification.
2. The 100 dB dynamic range of the AD630 exceeds that of any hybrid or IC balanced modulator/demodulator and is comparable to that of costly signal processing instruments.
3. The op amp format of the AD630 ensures easy implementation of high gain or complex switched feedback functions. The application resistors facilitate the implementation of most common applications with no additional parts.
4. The AD630 can be used as a 2-channel multiplexer with gains of 1, 2, 3, or 4. The channel separation of 100 dB at 10 kHz approaches the limit achievable with an empty IC package.
5. Laser trimming of the comparator and amplifying channel offsets eliminate the need for external nulling in most cases.

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## REVISION HISTORY

### 7/15—Rev. E to Rev. F

Updated Format.....	Universal
Changes to Features Section, General Description Section, Product Highlights Section, and Figure 1 .....	1
Added Applications Section.....	1
Changes to Table 3.....	4
Added Table 4; Renumbered Sequentially .....	5
Added Figure 4; Renumbered Sequentially and Table 5 .....	6
Added Figure 5 and Table 6.....	7
Added Table 7.....	8
Changes to Figure 7, Figure 8, and Figure 9.....	9
Changes to Figure 13, Figure 14, and Figure 15 .....	10
Added Test Circuits Section and Figure 16 to Figure 19.....	11
Added Theory of Operation Section.....	12
Change to Figure 24 .....	13
Updated Outline Dimensions.....	19
Changes to Ordering Guide .....	20

### 6/04—Rev. D to Rev. E

Changes to Ordering Guide .....	3
Replaced Figure 12 .....	9
Changes to AC Bridge Section.....	9
Replaced Figure 13 .....	10
Changes to Lock-In Amplifier Applications.....	10
Updated Outline Dimensions.....	11

### 6/01—Rev. C to Rev. D

Changes to Specification Table .....	2
Changes to Thermal Characteristics.....	3
Changes to Ordering Guide .....	3
Changes to Pin Configurations .....	3
Changes to Outline Dimensions .....	11

## SPECIFICATIONS

At 25°C and  $\pm V_S = \pm 15$  V, unless otherwise noted.

Table 1.

Parameter	AD630J/AD630A			AD630K/AD630B			AD630S			Unit
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
GAIN										
Open-Loop Gain	90	110		100	120		90	110		dB
±1, ±2 Closed-Loop Gain Error		0.1				0.05		0.1		%
Closed-Loop Gain Match		0.1				0.05		0.1		%
Closed-Loop Gain Drift		2			2			2		ppm/°C
CHANNEL INPUTS										
V <sub>IN</sub> Operational Limit <sup>1</sup>	(−V <sub>S</sub> + 4) to (+V <sub>S</sub> − 1)			(−V <sub>S</sub> + 4) to (+V <sub>S</sub> − 1)			(−V <sub>S</sub> + 4) to (+V <sub>S</sub> − 1)			V
Input Offset Voltage			500			100			500	μV
T <sub>MIN</sub> to T <sub>MAX</sub>			800			160			1000	μV
Input Bias Current	100	300		100	300		100	300		nA
Input Offset Current	10	50		10	50		10	50		nA
Channel Separation at 10 kHz	100			100			100			dB
COMPARATOR										
V <sub>IN</sub> Operational Limit <sup>1</sup>	(−V <sub>S</sub> + 3) to (+V <sub>S</sub> − 1.5)			(−V <sub>S</sub> + 3) to (+V <sub>S</sub> − 1.5)			(−V <sub>S</sub> + 3) to (+V <sub>S</sub> − 1.3)			V
Switching Window			±1.5			±1.5			±1.5	mV
T <sub>MIN</sub> to T <sub>MAX</sub>			±2.0			±2.0			±2.5	mV
Input Bias Current	100	300		100	300		100	300		nA
Response Time (−5 mV to +5 mV Step)	200			200			200			ns
Channel Status										
I <sub>SINK</sub> at V <sub>OL</sub> = −V <sub>S</sub> + 0.4 V <sup>2</sup>	1.6			1.6			1.6			mA
Pull-Up Voltage			(−V <sub>S</sub> + 33)			(−V <sub>S</sub> + 33)			(−V <sub>S</sub> + 33)	V
DYNAMIC PERFORMANCE										
Unity Gain Bandwidth	2			2			2			MHz
Slew Rate <sup>3</sup>	45			45			45			V/μs
Settling Time to 0.1% (20 V Step)	3			3			3			μs
OPERATING CHARACTERISTICS										
Common-Mode Rejection	85	105		90	110		90	110		dB
Power Supply Rejection	90	110		90	110		90	110		dB
Supply Voltage Range	±5		±16.5	±5		±16.5	±5		±16.5	V
Supply Current	4	5		4	5		4	5		mA
OUTPUT VOLTAGE, AT R <sub>L</sub> = 2 kΩ										
T <sub>MIN</sub> to T <sub>MAX</sub>	±10			±10			±10			V
Output Short-Circuit Current		25			25			25		mA
TEMPERATURE RANGES										
N Package	0		70	0		70				°C
D Package	−25		+85	−25		+85	−55		+125	°C

<sup>1</sup> If one terminal of each differential channel or comparator input is kept within these limits the other terminal may be taken to the positive supply.

<sup>2</sup>  $I_{SINK}$  at  $V_{OL} = (-V_S + 1$  V) is typically 4 mA.

<sup>3</sup> Pin 12 open. Slew rate with Pin 12 and Pin 13 shorted is typically 35 V/ $\mu$ s.

## ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage	$\pm 18$ V
Internal Power Dissipation	600 mW
Output Short-Circuit to Ground	Indefinite
Storage Temperature	
Ceramic Package	$-65^{\circ}\text{C}$ to $+150^{\circ}\text{C}$
Plastic Package	$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$
Lead Temperature Range (Soldering, 10 sec)	$300^{\circ}\text{C}$
Maximum Junction Temperature	$150^{\circ}\text{C}$

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

Table 3. Thermal Resistance

Package Type	$\theta_{JC}$	$\theta_{JA}$	Unit
20-Lead PDIP (N-20)	24	61	$^{\circ}\text{C}/\text{W}$
20-Lead SBDIP (D-20)	35	120	$^{\circ}\text{C}/\text{W}$
20-Lead LCC (E-20-4)	35	120	$^{\circ}\text{C}/\text{W}$
20-Lead SOIC_W (RW-20)	38	75	$^{\circ}\text{C}/\text{W}$

## CHIP AVAILABILITY

The AD630 is available in laser trimmed, passivated chip form. Figure 2 shows the AD630 metallization pattern, bonding pads, and dimensions. AD630 chips are available; consult factory for details.

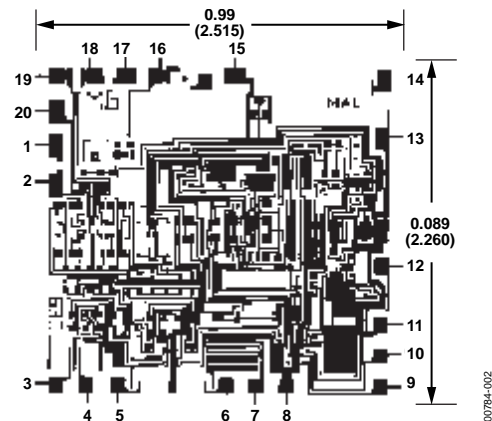


Figure 2. Chip Metallization and Pinout  
Dimensions shown in inches and (millimeters)  
Contact factory for latest dimensions

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

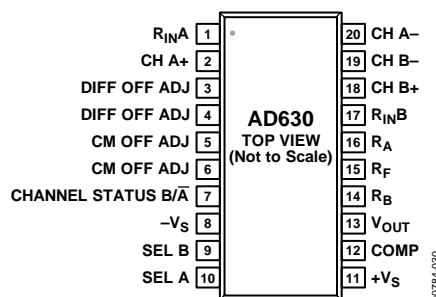


Figure 3. 20-Lead SOIC Pin Configuration

Table 4. 20-Lead SOIC Pin Function Descriptions

Pin No.	Mnemonic	Description
1	$R_{IN A}$	2.5 k $\Omega$ Resistor to Noninverting Input of Op Amp A
2	CH A+	Noninverting Input of Op Amp A
3	DIFF OFF ADJ	Differential Offset Adjustment
4	DIFF OFF ADJ	Differential Offset Adjustment
5	CM OFF ADJ	Common-Mode Offset Adjustment
6	CM OFF ADJ	Common-Mode Offset Adjustment
7	CHANNEL STATUS B/ $\bar{A}$	B or A Channel Status
8	$-V_S$	Negative Supply
9	SEL B	B Channel Comparator Input
10	SEL A	A Channel Comparator Input
11	$+V_S$	Positive Supply
12	COMP	Pin to Connect Internal Compensation Capacitor
13	$V_{OUT}$	Output Voltage
14	$R_B$	10 k $\Omega$ Gain Setting Resistor
15	$R_F$	10 k $\Omega$ Feedback Resistor
16	$R_A$	5 k $\Omega$ Feedback Resistor
17	$R_{IN B}$	2.5 k $\Omega$ Resistor to Noninverting Input of Op Amp B
18	CH B+	Noninverting Input of Op Amp B
19	CH B-	Inverting Input of Op Amp B
20	CH A-	Inverting Input of Op Amp A

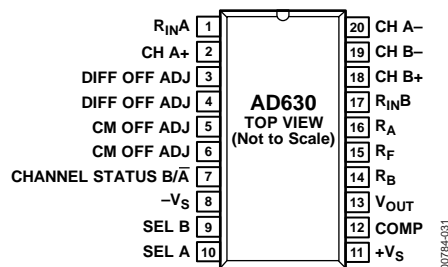


Figure 4. 20-Lead PDIP Pin Configuration

Table 5. 20-Lead PDIP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	$R_{INA}$	2.5 k $\Omega$ Resistor to Noninverting Input of Op Amp A
2	CH A+	Noninverting Input of Op Amp A
3	DIFF OFF ADJ	Differential Offset Adjustment
4	DIFF OFF ADJ	Differential Offset Adjustment
5	CM OFF ADJ	Common-Mode Offset Adjustment
6	CM OFF ADJ	Common-Mode Offset Adjustment
7	CHANNEL STATUS B/ $\bar{A}$	B or A Channel Status
8	$-V_S$	Negative Supply
9	SEL B	B Channel Comparator Input
10	SEL A	A Channel Comparator Input
11	$+V_S$	Positive Supply
12	COMP	Pin to Connect Internal Compensation Capacitor
13	$V_{OUT}$	Output Voltage
14	$R_B$	10 k $\Omega$ Gain Setting Resistor
15	$R_F$	10 k $\Omega$ Feedback Resistor
16	$R_A$	5 k $\Omega$ Feedback Resistor
17	$R_{INB}$	2.5 k $\Omega$ Resistor to Noninverting Input of Op Amp B
18	CH B+	Noninverting Input of Op Amp B
19	CH B-	Inverting Input of Op Amp B
20	CH A-	Inverting Input of Op Amp A

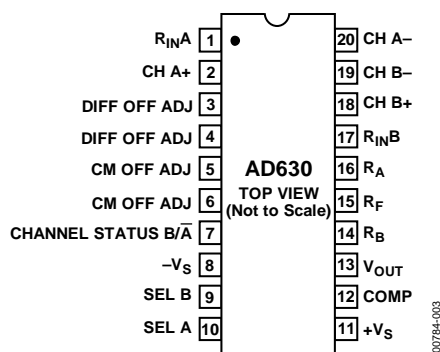


Figure 5. 20-Lead CERDIP Pin Configuration

Table 6. 20-Lead CERDIP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	R <sub>IN</sub> A	2.5 kΩ Resistor to Noninverting Input of Op Amp A
2	CH A+	Noninverting Input of Op Amp A
3	DIFF OFF ADJ	Differential Offset Adjustment
4	DIFF OFF ADJ	Differential Offset Adjustment
5	CM OFF ADJ	Common-Mode Offset Adjustment
6	CM OFF ADJ	Common-Mode Offset Adjustment
7	CHANNEL STATUS B/ $\bar{A}$	B or A Channel Status
8	-V <sub>S</sub>	Negative Supply
9	SEL B	B Channel Comparator Input
10	SEL A	A Channel Comparator Input
11	+V <sub>S</sub>	Positive Supply
12	COMP	Pin to Connect Internal Compensation Capacitor
13	V <sub>OUT</sub>	Output Voltage
14	R <sub>B</sub>	10 kΩ Gain Setting Resistor
15	R <sub>F</sub>	10 kΩ Feedback Resistor
16	R <sub>A</sub>	5 kΩ Feedback Resistor
17	R <sub>IN</sub> B	2.5 kΩ Resistor to Noninverting Input of Op Amp B
18	CH B+	Noninverting Input of Op Amp B
19	CH B-	Inverting Input of Op Amp B
20	CH A-	Inverting Input of Op Amp A

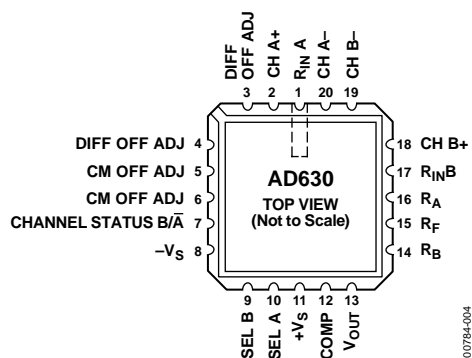


Figure 6. 20-Terminal CLCC Pin Configuration

Table 7. 20-Terminal CLCC Pin Function Descriptions

Pin No.	Mnemonic	Description
1	$R_{IN A}$	2.5 k $\Omega$ Resistor to Noninverting Input of Op Amp A
2	CH A+	Noninverting Input of Op Amp A
3	DIFF OFF ADJ	Differential Offset Adjustment
4	DIFF OFF ADJ	Differential Offset Adjustment
5	CM OFF ADJ	Common-Mode Offset Adjustment
6	CM OFF ADJ	Common-Mode Offset Adjustment
7	CHANNEL STATUS B/ $\overline{A}$	B or A Channel Status
8	$-V_S$	Negative Supply
9	SEL B	B Channel Comparator Input
10	SEL A	A Channel Comparator Input
11	$+V_S$	Positive Supply
12	COMP	Pin to Connect Internal Compensation Capacitor
13	$V_{OUT}$	Output Voltage
14	$R_B$	10 k $\Omega$ Gain Setting Resistor
15	$R_F$	10 k $\Omega$ Feedback Resistor
16	$R_A$	5 k $\Omega$ Feedback Resistor
17	$R_{IN B}$	2.5 k $\Omega$ Resistor to Noninverting Input of Op Amp B
18	CH B+	Noninverting Input of Op Amp B
19	CH B-	Inverting Input of Op Amp B
20	CH A-	Inverting Input of Op Amp A



## TYPICAL PERFORMANCE CHARACTERISTICS

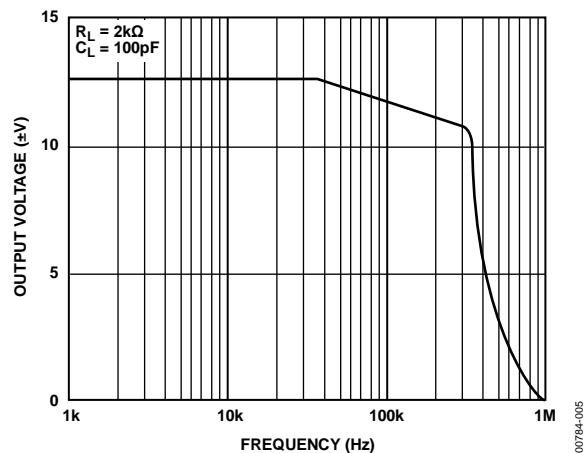


Figure 7. Output Voltage vs. Frequency (See Figure 16)

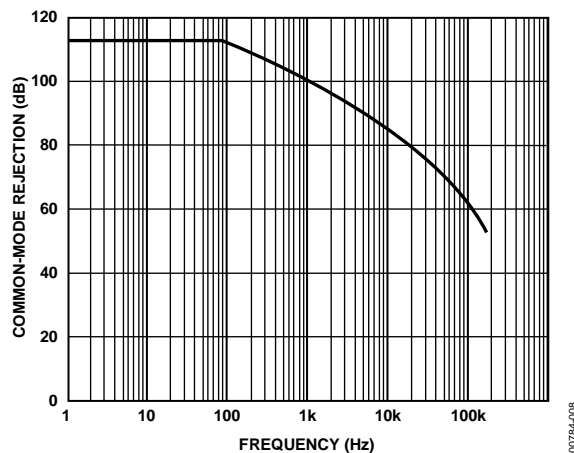


Figure 10. Common-Mode Rejection vs. Frequency

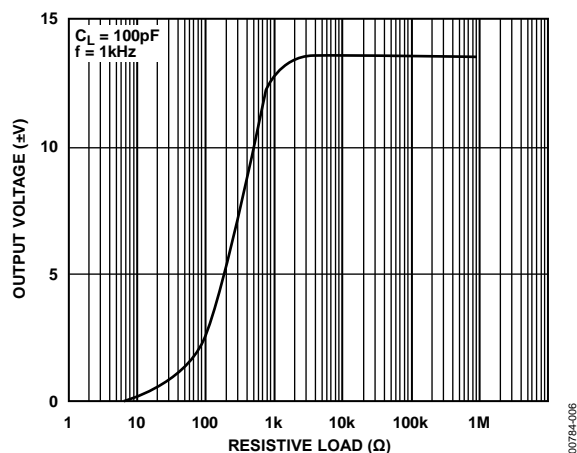


Figure 8. Output Voltage vs. Resistive Load (See Figure 16)

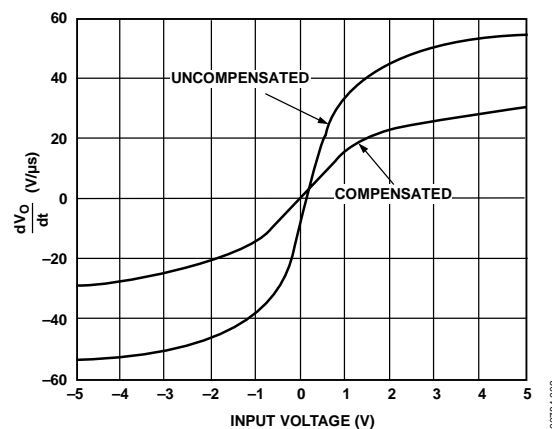
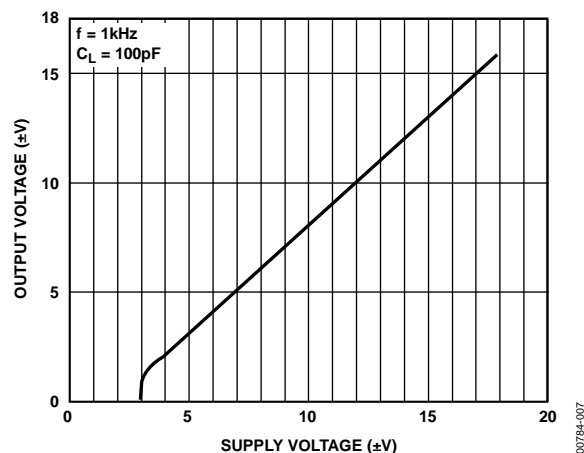
Figure 11.  $\frac{dV_O}{dt}$  vs. Input Voltage

Figure 9. Output Voltage Swing vs. Supply Voltage (See Figure 16)

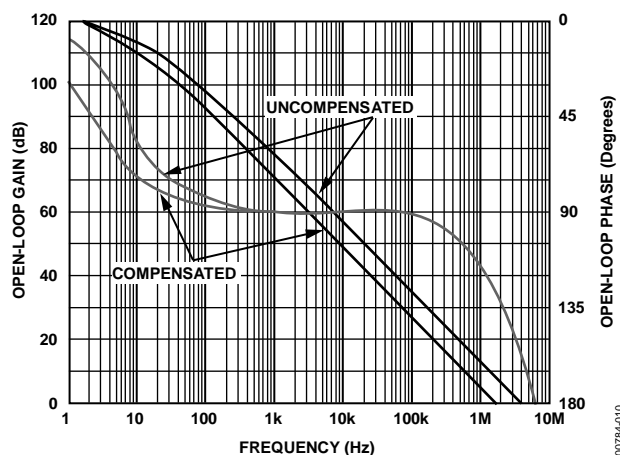


Figure 12. Gain and Phase vs. Frequency

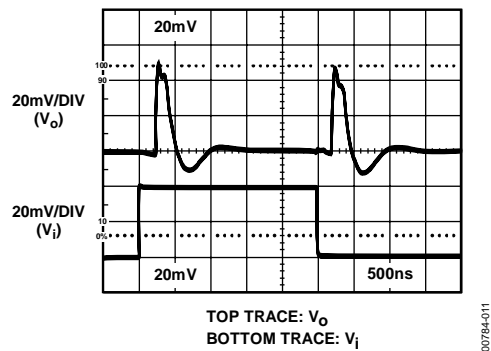


Figure 13. Channel-to-Channel Switch-Settling Characteristic (See Figure 17)

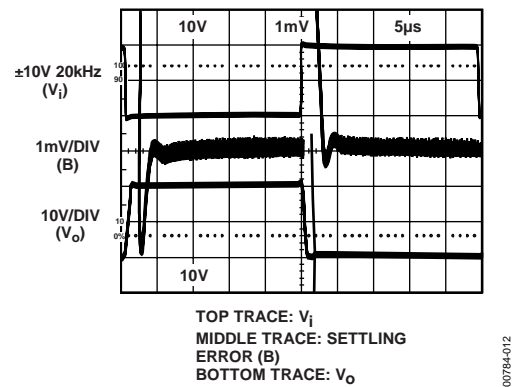


Figure 15. Large Signal Inverting Step Response (See Figure 19)

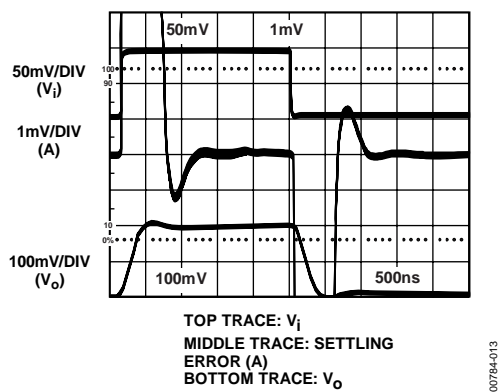
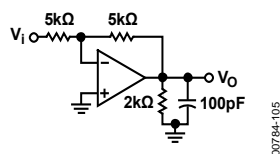


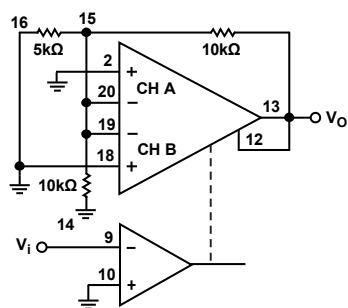
Figure 14. Small Signal Noninverting Step Response (See Figure 18)

## TEST CIRCUITS



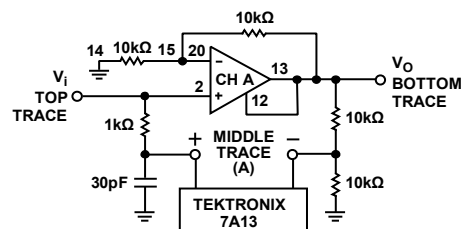
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Figure 16. Test Circuit for Output Voltage vs. Frequency, Resistive Load, and Supply Voltage (See Figure 7, Figure 8, and Figure 9)



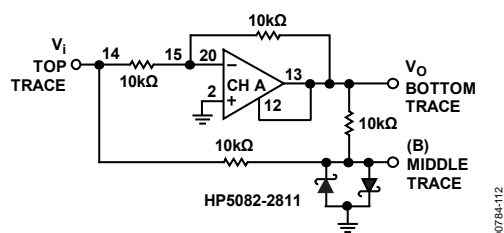
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Figure 17. Test Circuit for Channel-to-Channel Switch-Settling Characteristic (See Figure 13)



00784-113

Figure 18. Test Circuit for Small Signal Noninverting Step Response (See Figure 14)



00784-112

Figure 19. Test Circuit for Large Signal Noninverting Step Response (See Figure 15)

## THEORY OF OPERATION

### TWO WAYS TO LOOK AT THE AD630

The functional block diagram of the AD630 (see Figure 1) shows the pin connections of the internal functions. An alternative architectural diagram is shown in Figure 20. In this diagram, the individual A and B channel preamps, the switch, and the integrator output amplifier are combined in a single op amp. This amplifier has two differential input channels, only one of which is active at a time.

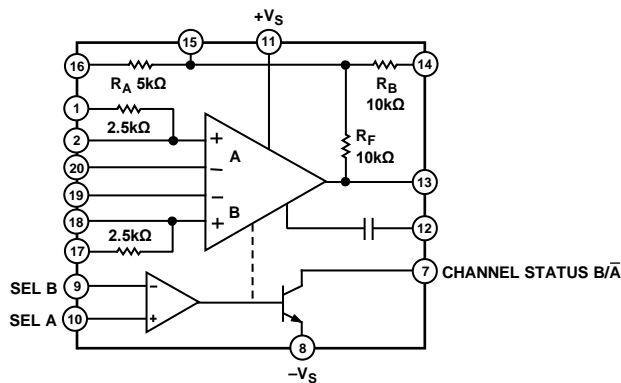


Figure 20. Architectural Block Diagram

### HOW THE AD630 WORKS

The basic mode of operation of the AD630 may be easier to recognize as two fixed gain stages, which can be inserted into the signal path under the control of a sensitive voltage comparator. When the circuit is switched between inverting and noninverting gain, it provides the basic modulation/demodulation function. The AD630 is unique in that it includes laser wafer trimmed thin-film feedback resistors on the monolithic chip. The configuration shown in Figure 21 yields a gain of  $\pm 2$  and can be easily changed to  $\pm 1$  by shifting  $R_B$  from its ground connection to the output.

The comparator selects one of the two input stages to complete an operational feedback connection around the AD630. The deselected input is off and has a negligible effect on operation.

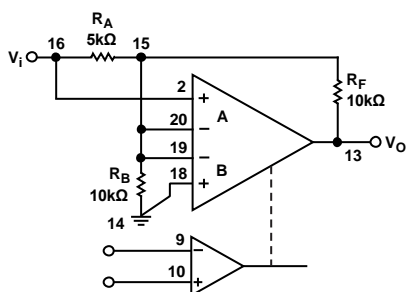


Figure 21. AD630 Symmetric Gain ( $\pm 2$ )

When Channel B is selected, the  $R_A$  and  $R_F$  resistors are connected for inverting feedback as shown in the inverting gain configuration diagram in Figure 22. The amplifier has sufficient loop gain to minimize the loading effect of  $R_B$  at the virtual ground produced by the feedback connection. When the sign of the comparator input is reversed, Input B is deselected and Input A is selected. The new equivalent circuit is the noninverting gain configuration shown in Figure 23. In this case,  $R_A$  appears across the op amp input terminals, but because the amplifier drives this difference voltage to zero, the closed-loop gain is unaffected.

The two closed-loop gain magnitudes are equal when  $R_F/R_A = 1 + R_F/R_B$ , which results from making  $R_A$  equal to  $R_F R_B / (R_F + R_B)$  the parallel equivalent resistance of  $R_F$  and  $R_B$ .

The 5 kΩ and the two 10 kΩ resistors on the AD630 chip can be used to make a gain of 2 as shown in Figure 22 and Figure 23. By paralleling the 10 kΩ resistors to make  $R_F$  equal to 5 kΩ and omitting  $R_B$ , the circuit can be programmed for a gain of  $\pm 1$  (as shown in Figure 28). These and other configurations using the on-chip resistors present the inverting inputs with a 2.5 kΩ source impedance. The more complete AD630 diagrams show 2.5 kΩ resistors available at the noninverting inputs which can be conveniently used to minimize errors resulting from input bias currents.

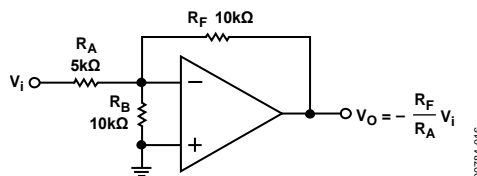


Figure 22. Inverting Gain Configuration

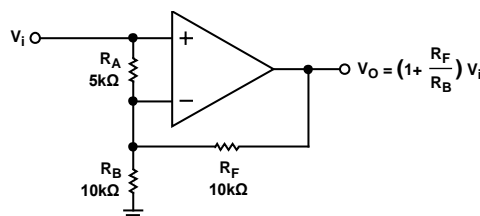


Figure 23. Noninverting Gain Configuration

## CIRCUIT DESCRIPTION

The simplified schematic of the AD630 is shown in Figure 24. It has been subdivided into three major sections, the comparator, the two input stages, and the output integrator. The comparator consists of a front end made up of Q52 and Q53, a flip-flop load formed by Q3 and Q4, and two current steering switching cells Q28, Q29 and Q30, Q31. This structure is designed so that a differential input voltage greater than 1.5 mV in magnitude applied to the comparator inputs completely selects one of the switching cells. The sign of this input voltage determines which of the two switching cells is selected.

The collectors of each switching cell connect to an input transconductance stage. The selected cell conveys bias currents  $i_{22}$  and  $i_{23}$  to the input stage it controls, causing it to become active. The deselected cell blocks the bias to its input stage, which, as a consequence, remains off.

The structure of the transconductance stages is such that it presents a high impedance at its input terminals and draws no bias current when deselected. The deselected input does not interfere with the operation of the selected input ensuring maximum channel separation.

Another feature of the input structure is that it enhances the slew rate of the circuit. The current output of the active stage follows a quasihyperbolic sine relationship to the differential input voltage. This means that the greater the input voltage, the harder this stage drives the output integrator, and the faster the output signal moves. This feature helps ensure rapid, symmetric settling when switching between inverting and noninverting closed loop configurations.

The output section of the AD630 includes a current mirror load (Q24 and Q25), an integrator voltage gain stage (Q32), and a complementary output buffer (Q44 and Q74). The outputs of both transconductance stages are connected in parallel to the current mirror. Because the deselected input stage produces no output current and presents a high impedance at its outputs, there is no conflict. The current mirror translates the differential output current from the active input transconductance amplifier into single-ended form for the output integrator. The complementary output driver then buffers the integrator output to produce a low impedance output.

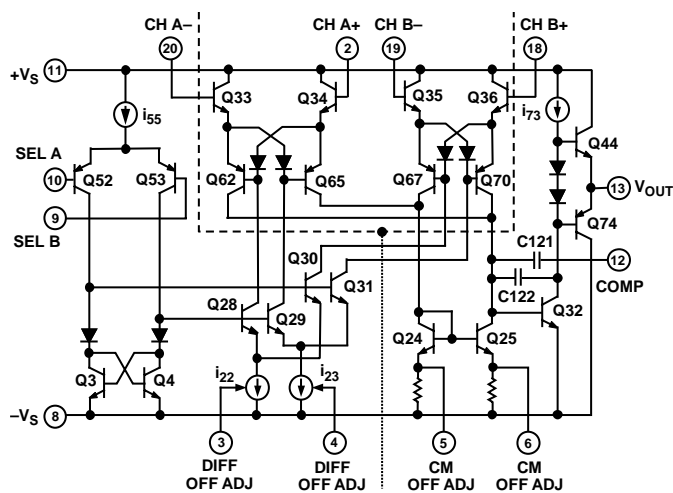


Figure 24. AD630 Simplified Schematic

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## OFFSET VOLTAGE NULLING

The offset voltages of both input stages and the comparator have been pretrimmed so that external trimming is only required in the most demanding applications. The offset adjustment of the two input channels is accomplished by means of a differential and common-mode scheme. This facilitates fine adjustment of system errors in switched gain applications. With the system input tied to 0 V, and a switching or carrier waveform applied to the comparator, a low level square wave appears at the output. The differential offset adjustment potentiometers can be used to null the amplitude of this square wave (Pin 3 and Pin 4). The common-mode offset adjustment can be used to zero the residual dc output voltage (Pin 5 and Pin 6). Implement these functions using 10 k $\Omega$  trim potentiometers with wipers connected directly to Pin 8 as shown in Figure 28 and Figure 29.

## CHANNEL STATUS OUTPUT

The channel status output, Pin 7, is an open collector output referenced to  $-V_S$  that can be used to indicate which of the two input channels is active. The output is active (pulled low) when Channel A is selected. This output can also be used to supply positive feedback around the comparator. This produces hysteresis which serves to increase noise immunity. Figure 26 shows an example of how hysteresis may be implemented. Note that the feedback signal is applied to the inverting ( $-$ ) terminal of the comparator to achieve positive feedback. This is because the open collector channel status output inverts the output sense of the internal comparator.

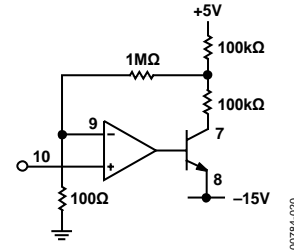


Figure 26. Comparator Hysteresis

The channel status output may be interfaced with TTL inputs as shown in Figure 27. This circuit provides appropriate level shifting from the open-collector AD630 channel status output to TTL inputs.

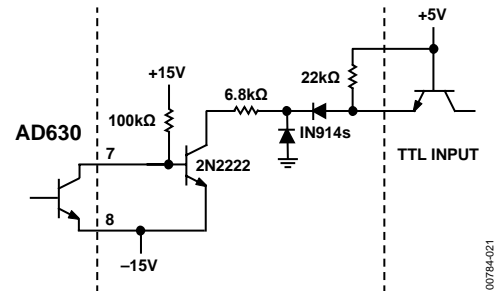


Figure 27. Channel Status—TTL Interface

## APPLICATIONS INFORMATION

### BALANCED MODULATOR

Perhaps the most commonly used configuration of the AD630 is the balanced modulator. The application resistors provide precise symmetric gains of  $\pm 1$  and  $\pm 2$ . The  $\pm 1$  arrangement is shown in Figure 28 and the  $\pm 2$  arrangement is shown in Figure 29. These cases differ only in the connection of the 10 k $\Omega$  feedback resistor (Pin 14) and the compensation capacitor (Pin 12). Note the use of the 2.5 k $\Omega$  bias current compensation resistors in these examples. These resistors perform the identical function in the  $\pm 1$  gain case. Figure 30 demonstrates the performance of the AD630 when used to modulate a 100 kHz square wave carrier with a 10 kHz sinusoid. The result is the double sideband suppressed carrier waveform.

These balanced modulator topologies accept two inputs, a signal (or modulation) input applied to the amplifying channels and a reference (or carrier) input applied to the comparator.

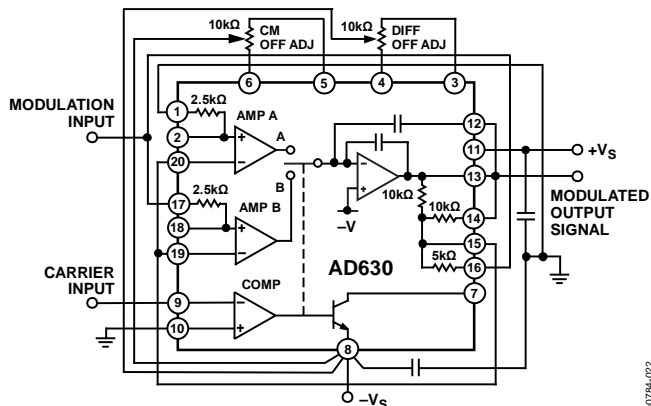


Figure 28. AD630 Configured as a Gain-of-One Balanced Modulator

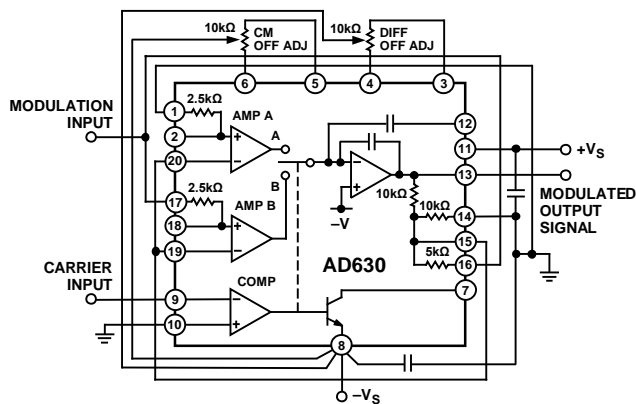


Figure 29. AD630 Configured as a Gain-of-Two Balanced Modulator

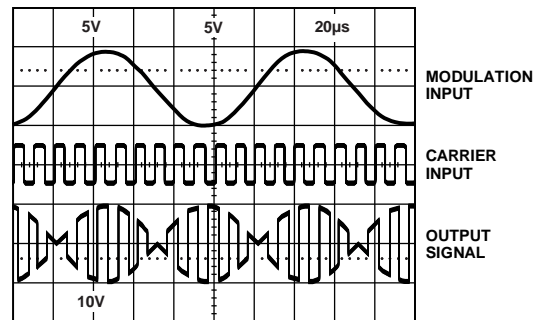


Figure 30. Gain-of-Two Balanced Modulator Sample Waveforms

### BALANCED DEMODULATOR

The balanced modulator topology described in the Balanced Modulator section also acts as a balanced demodulator if a double sideband suppressed carrier waveform is applied to the signal input and the carrier signal is applied to the reference input. The output under these circumstances is the baseband modulation signal. Higher order carrier components that can be removed with a low-pass filter are also present. Other names for this function are synchronous demodulation and phase-sensitive detection.

### PRECISION PHASE COMPARATOR

The balanced modulator topologies of Figure 28 and Figure 29 can also be used as precision phase comparators. In this case, an ac waveform of a particular frequency is applied to the signal input and a waveform of the same frequency is applied to the reference input. The dc level of the output (obtained by low-pass filtering) is proportional to the signal amplitude and phase difference between the input signals. If the signal amplitude is held constant, the output can be used as a direct indication of the phase. When these input signals are 90° out of phase, they are said to be in quadrature and the AD630 dc output is zero.

### PRECISION RECTIFIER ABSOLUTE VALUE

If the input signal is used as its own reference in the balanced modulator topologies, the AD630 acts as a precision rectifier. The high frequency performance is superior to that which can be achieved with diode feedback and op amps. There are no diode drops that the op amp must leap over with the commutating amplifier.



## LVDT SIGNAL CONDITIONER

Many transducers function by modulating an ac carrier. A linear variable differential transformer (LVDT) is a transducer of this type. The amplitude of the output signal corresponds to core displacement. Figure 31 shows an accurate synchronous demodulation system, which can be used to produce a dc voltage that corresponds to the LVDT core position. The inherent precision and temperature stability of the AD630 reduce demodulator drift to a second-order effect.

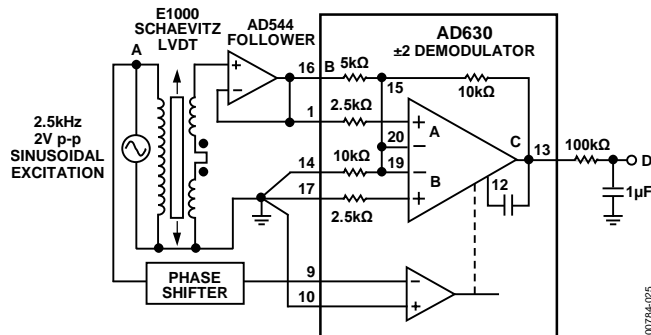


Figure 31. LVDT Signal Conditioner

## AC BRIDGE

Bridge circuits that use dc excitation are often plagued by errors caused by thermocouple effects,  $1/f$  noise, dc drifts in the electronics, and line noise pick-up. One way to get around these problems is to excite the bridge with an ac waveform, amplify the bridge output with an ac amplifier, and synchronously demodulate the resulting signal. The ac phase and amplitude information from the bridge is recovered as a dc signal at the output of the synchronous demodulator. The low frequency system noise, dc drifts, and demodulator noise all get mixed to the carrier frequency and can be removed by means of a low-pass filter. Dynamic response of the bridge must be traded off against the amount of attenuation required to adequately suppress these residual carrier components in the selection of the filter.

Figure 33 is an example of an ac bridge system with the AD630 used as a synchronous demodulator. The bridge is excited by a 1 V 400 Hz excitation. Trace A in Figure 32 is the amplified bridge signal. Trace B is the output of the synchronous demodulator and Trace C is the filtered dc system output.

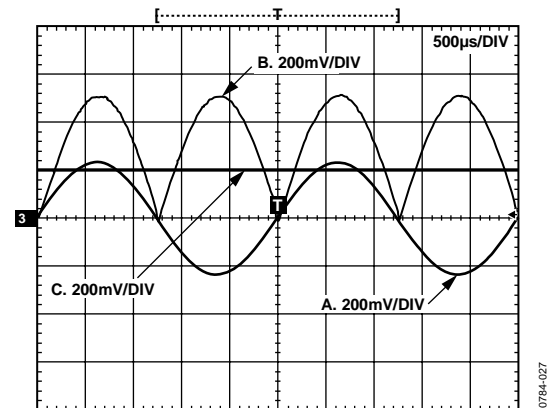


Figure 32. AC Bridge Waveforms (1 V Excitation)

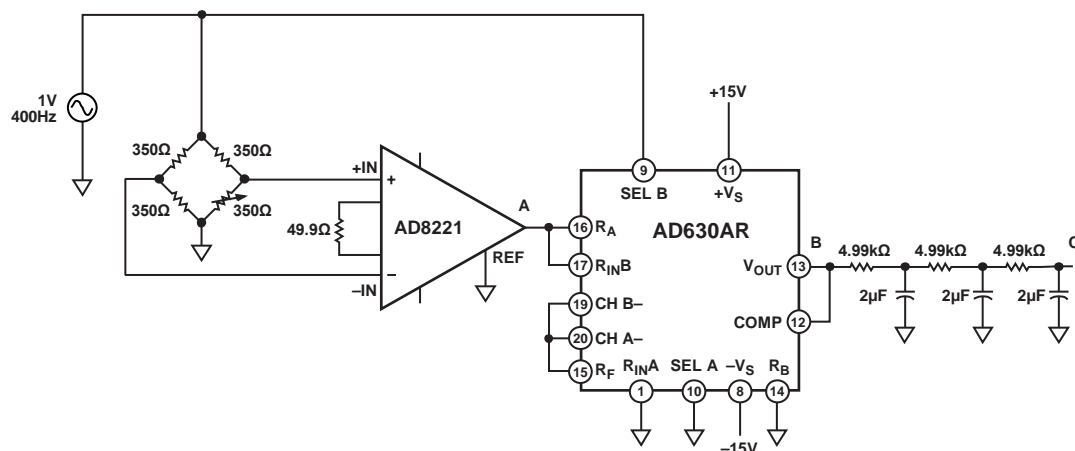


Figure 33. AC Bridge System

## LOCK-IN AMPLIFIER APPLICATIONS

Lock-in amplification is a technique used to separate a small, narrow-band signal from interfering noise. The lock-in amplifier acts as a detector and narrow-band filter combined. Very small signals can be detected in the presence of large amounts of uncorrelated noise when the frequency and phase of the desired signal are known.

The lock-in amplifier is basically a synchronous demodulator followed by a low-pass filter. An important measure of performance in a lock-in amplifier is the dynamic range of its demodulator. The schematic diagram of a demonstration circuit which exhibits the dynamic range of an AD630 as it might be used in a lock-in amplifier is shown in Figure 35. Figure 34 is an oscilloscope photo demonstrating the large dynamic range of the AD630. The photo shows the recovery of a signal modulated at 400 Hz from a noise signal approximately 100,000 times larger.

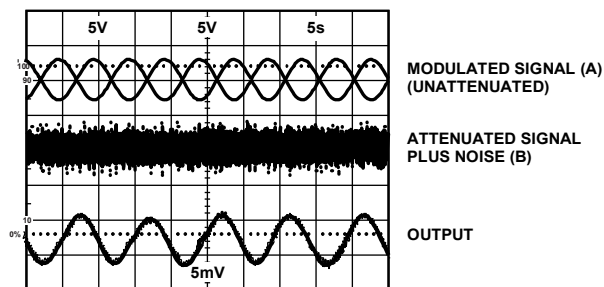


Figure 34. Lock-In Amplifier Waveforms

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The test signal is produced by modulating a 400 Hz carrier with a 0.1 Hz sine wave. The signals produced, for example, by chopped radiation (that is, IR, optical) detectors may have similar low frequency components. A sinusoidal modulation is used for clarity of illustration. This signal is produced by a circuit similar to Figure 28 and is shown in the upper trace of Figure 34. It is attenuated 100,000 times normalized to the output, B, of the summing amplifier. A noise signal that might represent, for example, background and detector noise in the chopped radiation case, is added to the modulated signal by the summing amplifier. This signal is simply band limited, clipped white noise. Figure 34 shows the sum of attenuated signal plus noise in the center trace. This combined signal is demodulated synchronously using phase information derived from the modulator, and the result is low-pass filtered using a 2-pole simple filter which also provides a gain of 100 to the output. This recovered signal is the lower trace of Figure 34.

The combined modulated signal and interfering noise used for this illustration is similar to the signals often requiring a lock-in amplifier for detection. The precision input performance of the AD630 provides more than 100 dB of signal range and its dynamic response permits it to be used with carrier frequencies more than two orders of magnitude higher than in this example. A more sophisticated low-pass output filter aids in rejecting wider bandwidth interference.

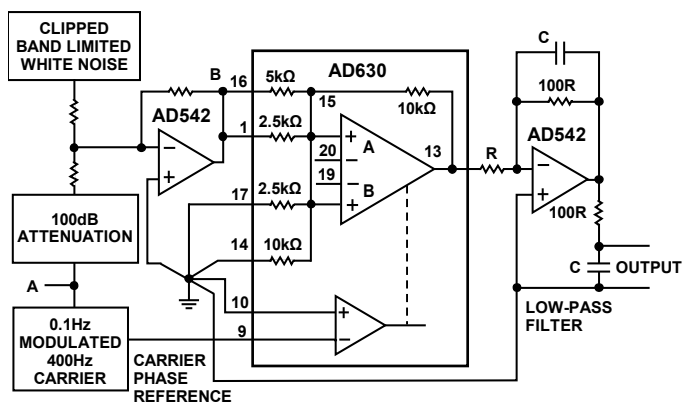
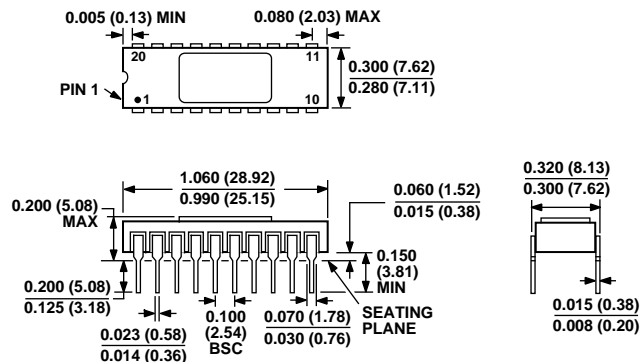


Figure 35. Lock-In Amplifier

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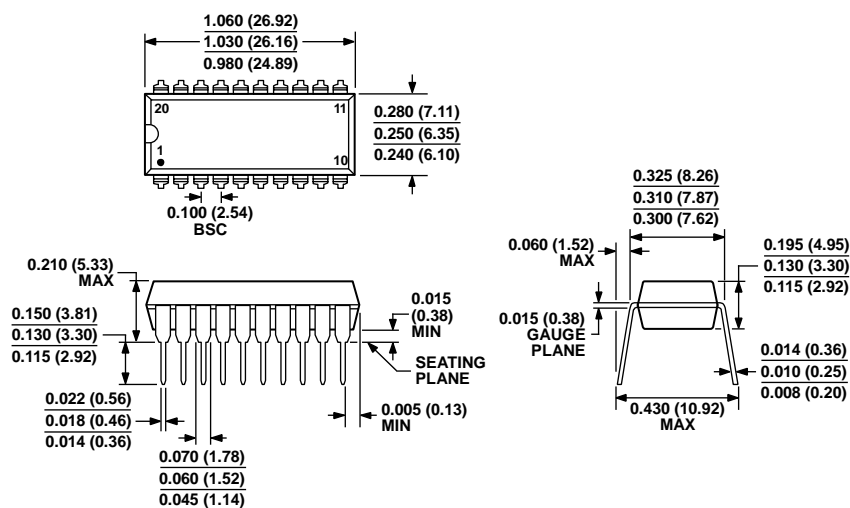
## OUTLINE DIMENSIONS



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Figure 36. 20-Lead Side-Brazed Ceramic Dual In-Line Package [SBDIP] (D-20)

Dimensions shown in inches and (millimeters)



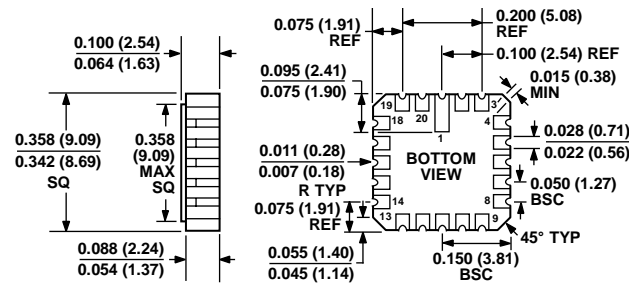
COMPLIANT TO JEDEC STANDARDS MS-001

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 37. 20-Lead Plastic Dual In-Line Package [PDIP] Narrow Body (N-20)

Dimensions shown in inches and (millimeters)

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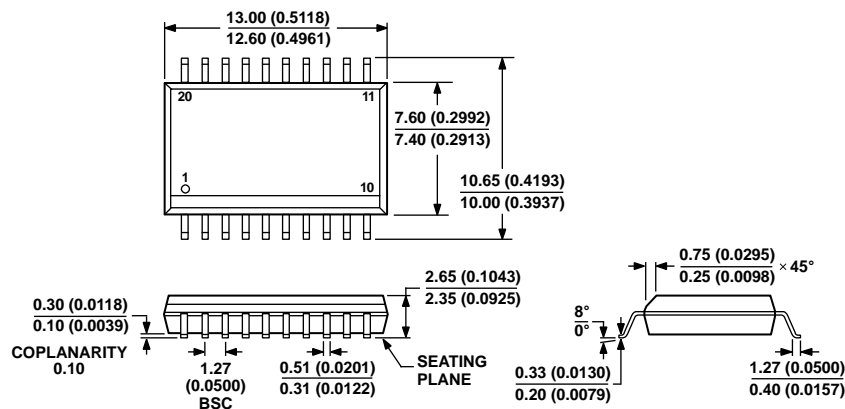


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Figure 38. 20-Terminal Ceramic Leadless Chip Carrier [LCC] (E-20-1)

Dimensions shown in inches and (millimeters)



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Figure 39. 20-Lead Standard Small Outline Package [SOIC\_W] Wide Body (RW-20)

Dimensions shown in millimeters and (inches)

## ORDERING GUIDE

Model <sup>1</sup>	Temperature Range	Package Description	Package Option
AD630JNZ	0°C to 70°C	20-Lead Plastic Dual In-Line Package [PDIP]	N-20
AD630KNZ	0°C to 70°C	20-Lead Plastic Dual In-Line Package [PDIP]	N-20
AD630ARZ	−25°C to +85°C	20-Lead Standard Small Outline Package [SOIC_W]	RW-20
AD630ARZ-RL	−25°C to +85°C	20-Lead Standard Small Outline Package [SOIC_W], 13" Tape and Reel	RW-20
AD630ADZ	−25°C to +85°C	20-Lead Side-Brazed Ceramic Dual In-Line Package [SBDIP]	D-20
AD630BDZ	−25°C to +85°C	20-Lead Side-Brazed Ceramic Dual In-Line Package [SBDIP]	D-20
AD630SD	−55°C to +125°C	20-Lead Side-Brazed Ceramic Dual In-Line Package [SBDIP]	D-20
AD630SD/883B	−55°C to +125°C	20-Lead Side-Brazed Ceramic Dual In-Line Package [SBDIP]	D-20
5962-8980701RA	−55°C to +125°C	20-Lead Side-Brazed Ceramic Dual In-Line Package [SBDIP]	D-20
AD630SE/883B	−55°C to +125°C	20-Terminal Ceramic Leadless Chip Carrier [LCC]	E-20-1
5962-89807012A	−55°C to +125°C	20-Terminal Ceramic Leadless Chip Carrier [LCC]	E-20-1
AD630SCHIPS	−55°C to +125°C	Chip	

<sup>1</sup> Z = RoHS Compliant Part.

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